What is claimed is:

- 1. A sulfuric acid recycle apparatus for recycling sulfuric acid in a wafer cleaning fluid prepared by mixing sulfuric acid and hydrogen peroxide solution comprising:
- a reaction bath having two openings formed of at least an introduction port and a discharge port for obtaining concentrated sulfuric acid by concentrating sulfuric acid in the wafer cleaning waste fluid introduced from the introduction port upon completion of a wafer cleaning process, then discharging the concentrated sulfuric acid from the discharge port;

a wafer processing bath for processing wafers; and

- a supply unit for supplying the concentrated sulfuric acid to the wafer processing bath.
- 2. The sulfuric acid recycle apparatus according to Claim 1, wherein the reaction bath includes therein heating units for heating the wafer cleaning waste fluid and a gas discharge port for discharging a gas produced from the wafer cleaning waste fluid when it is heated by the heating unit; and
- a suction unit for sucking the gas is connected to the gas discharge port.
- 3. The sulfuric acid recycle apparatus according to Claim 1 or 2, wherein the reaction bath includes therein a plurality of partition plates for changing an advancing direction of the wafer cleaning waste fluid, and an inclination plate positioned at a portion closer to the gas discharge port than the partition plates for allowing the concentrated sulfuric acid to flow along the surface thereof.
- 4. The sulfuric acid recycle apparatus according to Claim 3, wherein the inclination plate has irregularities on its surface.
- 5. The sulfuric acid recycle apparatus according to any of Claims 1 to 4, wherein the reaction bath has a waterdrop storage bath for preventing waterdrop attached to a ceiling surface of the reaction bath from being mixed with the concentrated sulfuric acid.
  - 6. The sulfuric acid recycle apparatus according to any of

Claims 1 to 5, wherein fresh sulfuric acid is supplied to the concentrated sulfuric acid.

7. The sulfuric acid recycle apparatus according to any of Claims 2 to 6, wherein a heating temperature in the reaction bath ranges from 150 °C to 350 °C.